

Description

The AOD210 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

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TO-252-2L

General Features

 $V_{DS} = 30V I_{D} = 150A$

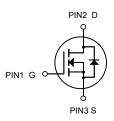
 $R_{DS(ON)}$ < 2.9 mQ@ V_{GS}=10V

Application

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
AOD210	TO-252-2L	HXY MOSFET	2500

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units	
Vos	Drain-Source Voltage	30	V	
Vgs	Gate-Source Voltage	±20	V	
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	150	А	
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	Drain Current, V _{GS} @ 10V ¹ 80		
Ірм	Pulsed Drain Current ²	450	А	
EAS	Single Pulse Avalanche Energy ³	580	mJ	
las	Avalanche Current	60	А	
P _D @T _C =25°C	Total Power Dissipation ⁴	87	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
RθJA	Thermal Resistance Junction-Ambient 1	62 °C/W		
RθJC	Thermal Resistance Junction-Case1	2.1 °C/W		



Electrical characteristic ($T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain to source breakdown voltage	V _{GS} =0V, I _D =250uA	30			V
ΔBV_{DSS} / ΔT_{J}	Breakdown voltage temperature coefficient	I _D =250uA, referenced to 25°C		0.02		V/ºC
1	Drain to source leakage current	V _{DS} =30V, V _{GS} =0V			1	uA
I _{DSS}	Drain to source leakage current	V _{DS} =24V, T _J =125°C			50	uA
	Gate to source leakage current, forward	V _{GS} =20V, V _{DS} =0V			100	nA
I _{GSS}	Gate to source leakage current, reverse	V _{GS} =-20V, V _{DS} =0V			-100	nA
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS}=V_{GS}$, $I_{D}=250uA$	1.2		2.4	V
		V _{GS} =4.5V, I _D =30A,T _J =25°C		2.2	4.8	mΩ
$R_{DS(ON)}$	Drain to source on state resistance	V _{GS} =10V, I _D =30A,T _J =25°C		1.5	2.9	mΩ
		V _{GS} =10V, I _D =30A,T _J =125°C		2.5		mΩ
G_fs	Forward transconductance	V _{DS} =5V, I _D =30A		73		S
C _{iss}	Input capacitance			6272		pF
C_{oss}	Output capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz		1022		
C _{rss}	Reverse transfer capacitance			718		
$t_{d(on)}$	Turn on delay time			20		ns
t _r	Rising time	V_{DS} =15V, I_{D} =30A, R_{G} =4.7 Ω ,		58		
t _{d(off)}	Turn off delay time	V _{GS} =10V (note 4,5)		158		
t _f	Fall time	(11010-1,0)		77		
Q_g	Total gate charge	V _{DS} =24V, V _{GS} =10V, I _D =30A,		143		nC
Q_{gs}	Gate-source charge	I _G =5mA		17		
Q_{gd}	Gate-drain charge	(note 4,5)		43		
R_g	Gate resistance	V _{DS} =0V, Scan F mode		4.2		Ω
I _s	Continuous source current	Integral reverse p-n Junction			110	A
I _{SM}	Pulsed source current	diode in the MOSFET			440	Α
V _{SD}	Diode forward voltage drop.	I _S =45A, V _{GS} =0V			1.4	V
t _{rr}	Reverse recovery time	I _S =30A, V _{GS} =0V,		26		ns
Q _{rr}	Reverse recovery charge	dI _F /dt=100A/us		10		nC

※. Notes

- Repeatitive rating : pulse width limited by junction temperature. L =0.5mH, I_{AS} =48A, V_{DD} =30V, R_{G} =25 Ω , Starting T_{J} = 25 $^{\circ}$ C I_{SD} ≤30A, di/dt = 100A/us, V_{DD} ≤ BV $_{DSS}$, Staring T_{J} =25 $^{\circ}$ C Pulse Test : Pulse Width ≤ 300us, duty cycle ≤ 2%. 1.
- 3.

Typical Electrical and Thermal Characteristics

Fig. 1. On-state characteristics

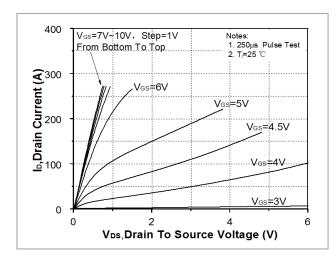


Fig. 3. On-resistance variation vs. drain current and gate voltage

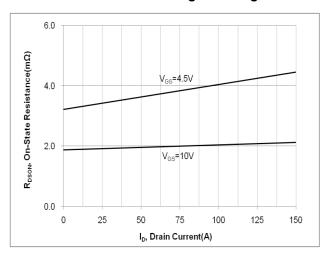


Fig 5. Breakdown voltage variation vs. junction temperature

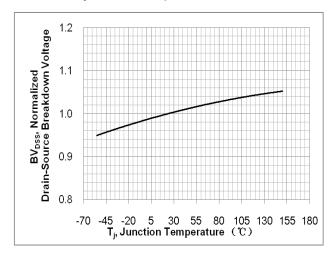


Fig. 2. Transfer Characteristics

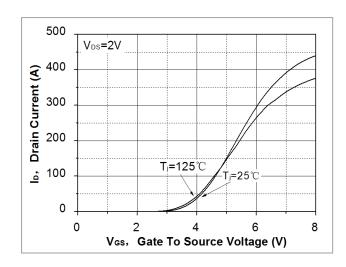


Fig. 4. On-state current vs. diode forward voltage

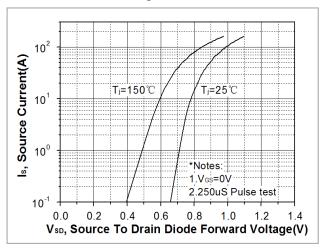


Fig. 6. On-resistance variation vs. junction temperature

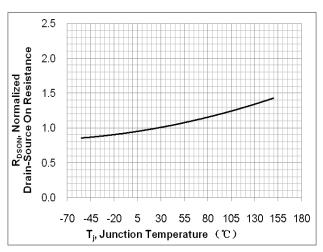


Fig. 7. Gate charge characteristics

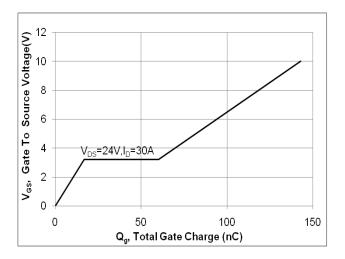


Fig. 9. Maximum safe operating area

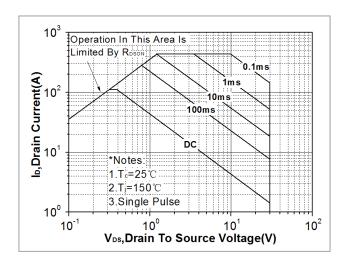


Fig. 11. Transient thermal response curve

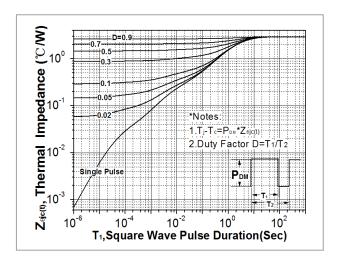


Fig. 8. Capacitance Characteristics

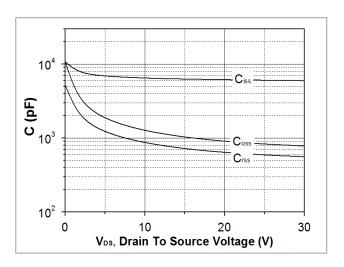
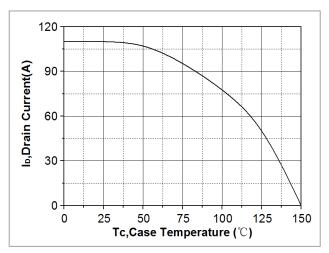


Fig. 10. Maximum drain current vs. case temperature



Test Circuit

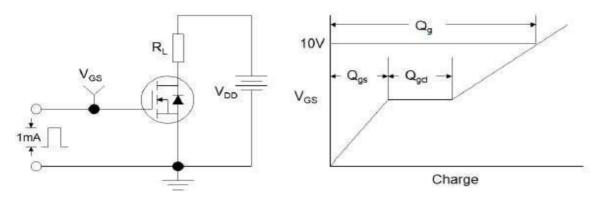


Figure1:Gate Charge Test Circuit & Waveform

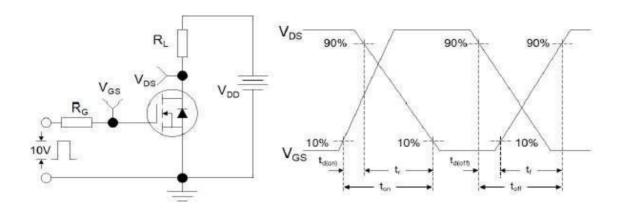


Figure 2: Resistive Switching Test Circuit & Waveforms

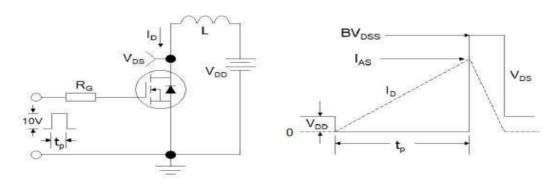
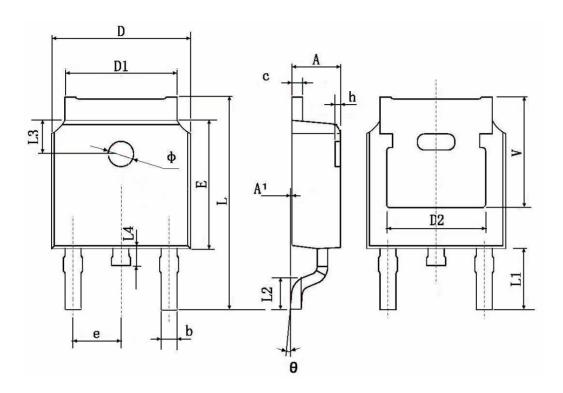


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms

TO-252-2L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.483 TYP.		0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		



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